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10-20-1998

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To the Honorable Commissioner of Patent



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09/16/98  
10/05/98

## 1. Name of conveying party(ies):

Haruhiko MATSUMOTO, Nobuhito EBINE, Toshikazu  
SEKIGUCHI

10.5.98

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other \_\_\_\_\_

Execution Date: August 26, 1998

## 2. Name and address of receiving party(ies)

Name: Japan Solderless Terminal Manufacturing  
Co., Ltd  
Internal Address: \_\_\_\_\_Street Address: 4-8, Minamisenba 2-chome, Chuo-kuOsaka JAPAN

City: \_\_\_\_\_ State: \_\_\_\_\_ ZIP: \_\_\_\_\_

Additional name(s) & address(es) attached? ☒ Yes ☐ No

## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: August 26, 1998

A. Patent Application No.(s)

B. Patent No.(s)

09/166/29

Additional numbers attached? ☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP

Internal Address: \_\_\_\_\_

Street Address: 1300 NORTH SEVENTEENTH STREET  
SUITE 1800City: ARLINGTON State: VA ZIP: 222096. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41).....\$ 40.00☒ Enclosed☐ Authorized to be charged to deposit account

## 8. Deposit account number:

01-2135

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## 9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Alan E. Schiavelli  
Name of Person Signing 32,087

Signature

October 5, 1998  
DateTotal number of pages including cover sheet, attachments, and document: 3

PATENT

REEL: 9514 FRAME: 0437

Name and Address of Additional Receiving Party:

Name: Sony Corporation

Street Address: 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo, Japan

# ASSIGNMENT

For good and valuable consideration, the sufficiency and receipt of which is hereby acknowledged, as a below named inventor, I hereby sell and assign to the following assignees, namely

- (1) Japan Solderless Terminal Manufacturing Co., Ltd.  
4-8, Minamisenba 2-chome, Chuo-ku, Osaka JAPAN, and  
 of \_\_\_\_\_
- (2) Sony Corporation  
7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo JAPAN  
 of \_\_\_\_\_

its successors and assigns or other legal representatives all my rights, title and interest, in and for the United States of America, in and to

## CONNECTOR FOR PRINTED CIRCUIT BOARDS

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed by me even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said assignees

\_\_\_\_\_, its successors, assigns or other legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said \_\_\_\_\_ assignees

- |                     |  | (Full Name)                                 | (Signature)              |
|---------------------|--|---|--------------------------|
| 1) Date             | <u>August 26, 1998</u>                     | Inventor <u>Haruhiko Matsumoto</u>          | <u>H. Matsumoto</u>      |
| Residence           | <u>539-3-3-203, Kamoshidacho, Aoba-ku,</u> |   |                          |
| Post Office Address | <u>ditto</u>                               | <u>Yokohama, Kanagawa JAPAN</u>             | Citizenship <u>Japan</u> |
| 2) Date             | <u>August 26, 1998</u>                     | Inventor <u>Nobuhito Ebine</u>              | <u>Nobuhito Ebine</u>    |
| Residence           | <u>2-9-3-1203, Nakagawa, Tsuzuki-ku,</u>   |   |                          |
| Post Office Address | <u>ditto</u>                               | <u>Yokohama, Kanagawa JAPAN</u>             | Citizenship <u>Japan</u> |
| 3) Date             | <u>August 26, 1998</u>                     | Inventor <u>Toshikazu Sekiguchi</u>         | <u>T. Sekiguchi</u>      |
| Residence           | <u>Famele-Totsuka 341, 636-1, Yabecho,</u> |   |                          |
| Post Office Address | <u>ditto</u>                               | <u>Totsuka-ku, Yokohama, Kanagawa JAPAN</u> | Citizenship <u>Japan</u> |

Witness(es)

- All) H. Takai 2) \_\_\_\_\_ 4) \_\_\_\_\_
- 1) \_\_\_\_\_ 3) \_\_\_\_\_ 5) \_\_\_\_\_